

\*This document summarizes major features of the device. The contents of this document are preliminary. A formal specification is separately provided by "DATA SHEET".

	Analog LSI Design & Product Support Dept. System Solution LSI Division <b>FUJITSU LIMITED</b>	<b>Version 2.0</b> <b>Date: Nov/2001</b>
<p>ASSP For Power Management Applications <b>2-Channel DC/DC Converter IC</b> with Overcurrent Protection</p> <p><b>MB39A104</b></p>		

### **DESCRIPTION**

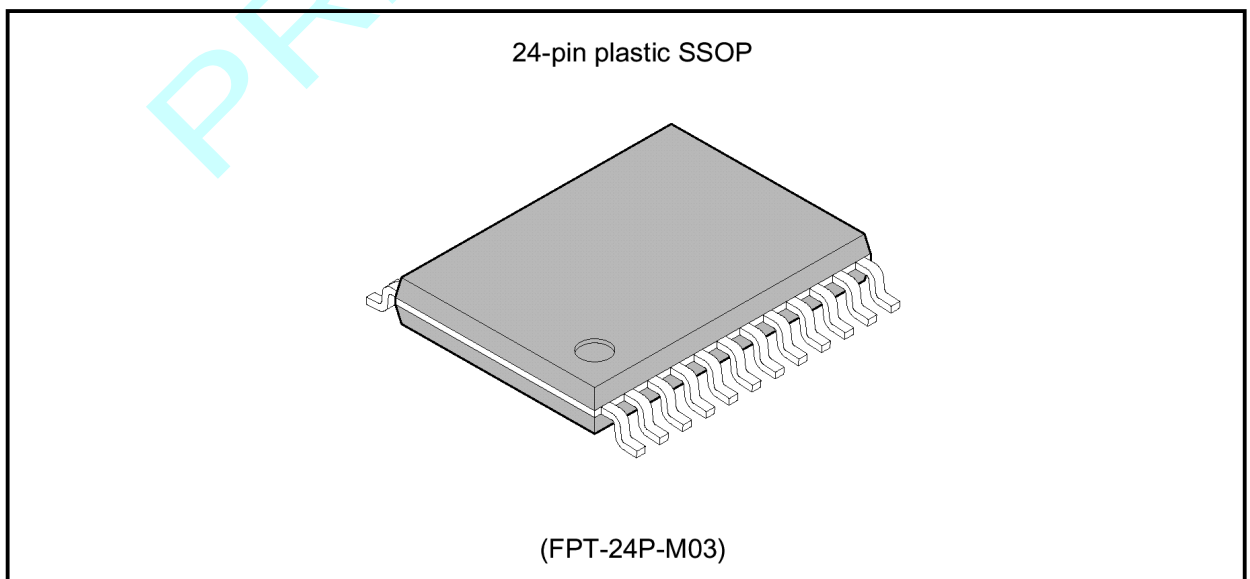
The MB39A104 is a 2-channel pulse width modulation (PWM) DC/DC converter IC with over current protection. This IC corresponds to the operation of wide range (7V to 19V) of the power supply voltage. This IC can be operated by high frequency, therefore the value of the coil can be reduced.

In addition, the DC/DC converter can be few external parts, and various application of the LCD monitor etc. can be achieved by a low cost.

### **FEATURES**

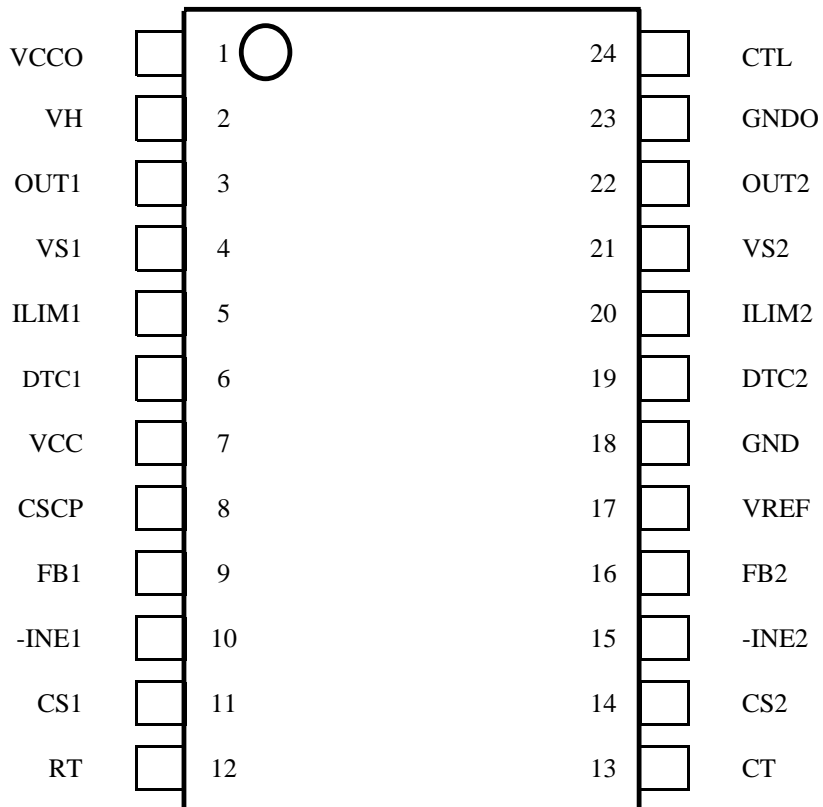
- Wide input voltage operating range :7V to 19V
- High frequency operation :1MHz (Max)
- High precision reference voltage : 5.0V  $\pm$  1%
- Built-in over current protection
- Built-in standby current function:0 $\mu$ A(typ)
- Built-in circuit for load-independent soft-start
- Built-in totem-pole output stage supporting P-channel MOS FETs devices.

### **PACKAGE**



## **PIN ASSIGNMENT**

(TOP VIEW)

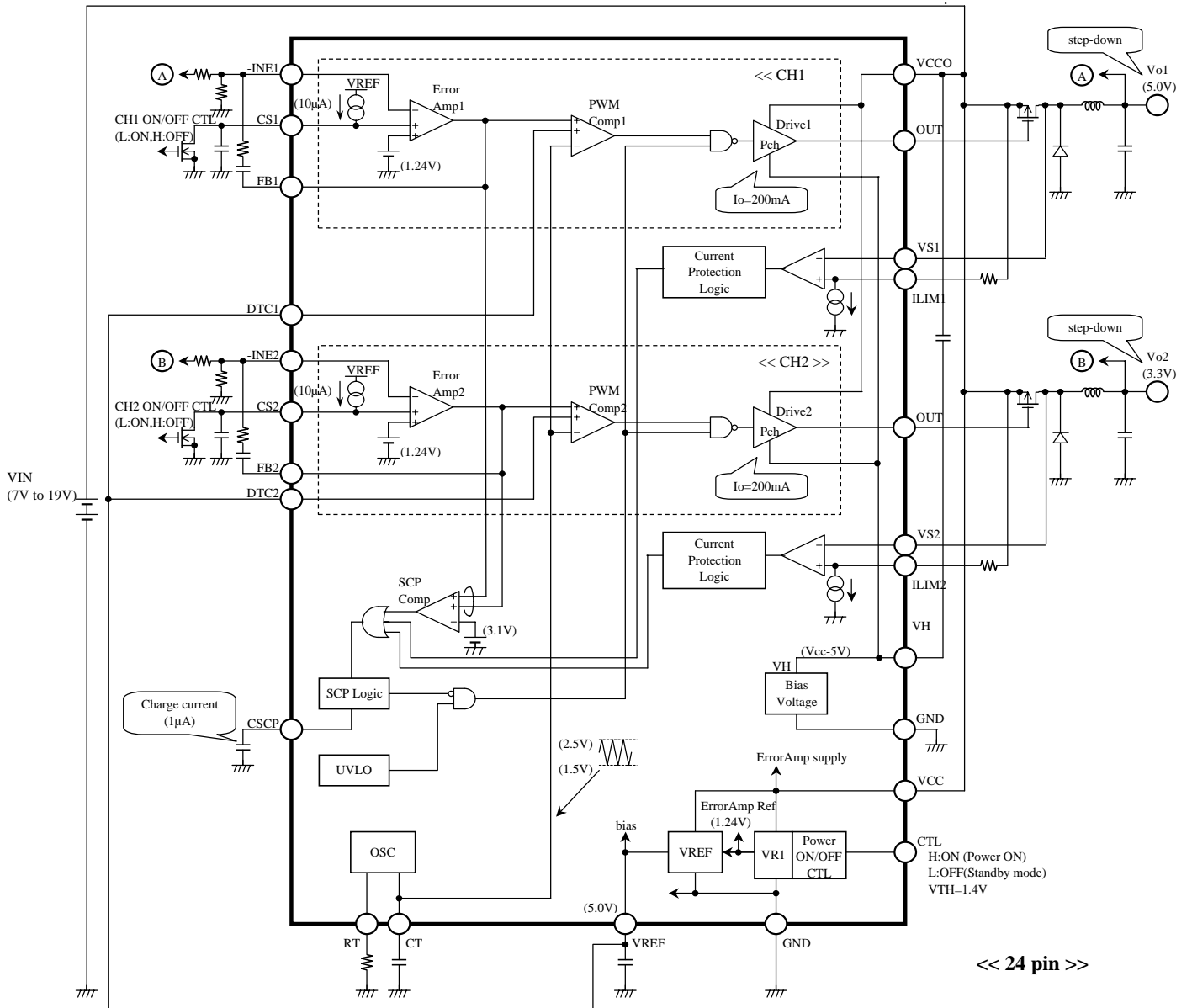


(FPT-24P-M03)

## ■ PIN DESCRIPTION

Pin no.	Symbol	I/O	Descriptions
1	VCCO	-	Output circuit power supply terminal.
2	VH	O	Power supply terminal for FET drive circuit (VH = VCC - 5 V)
3	OUT1	O	CH1 external Pch FET gate drive terminal.
4	VS1	I	CH1 overcurrent protection circuit input terminal.
5	ILIM1	I	CH1 overcurrent detection resistor connection terminal. The overcurrent detection reference voltage is set by external resistance and the internal current source (110 $\mu$ A at RT=24k $\Omega$ ).
6	DTC1	I	CH1 PWM comparator input terminal. The output is controlled by the lowest voltages in FB1 and the DTC1 terminal voltage.
7	VCC	-	Power supply terminal for reference voltage and control circuit.
8	CSCP	-	Timer-latch short-circuit protection capacitor connection terminal.
9	FB1	O	CH1 Error amplifier (Error Amp 1) output terminal.
10	-INE1	I	CH1 Error amplifier (Error Amp 1) inverted input terminal.
11	CS1	-	CH1 Soft-start capacitor connection terminal.
12	RT	-	Triangular-wave oscillation frequency setting resistor connection terminal.
13	CT	-	Triangular-wave oscillation frequency setting capacitor connection terminal.
14	CS2	-	CH2 Soft-start capacitor connection terminal.
15	-INE2	I	CH2 Error amplifier (Error Amp 2) inverted input terminal.
16	FB2	O	CH2 Error amplifier (Error Amp 2) output terminal.
17	VREF	O	Reference voltage output terminal.
18	GND	-	Output circuit ground terminal.
19	DTC2	I	CH2 PWM comparator input terminal. The output is controlled by the lowest voltages in FB2 the DTC2 terminal voltage.
20	ILIM2	I	CH2 overcurrent detection resistor connection terminal. The overcurrent detection reference voltage is set by external resistance and the internal current source (110 $\mu$ A at RT=24k $\Omega$ ).
21	VS2	I	CH2 overcurrent protection circuit input terminal.
22	OUT2	O	CH2 external FET gate drive terminal.
23	GNDO	-	Output circuit ground terminal.
24	CTL	I	Power supply control terminal “H” level : IC operating mode “L” level : IC standby mode

# BLOCK DIAGRAM



## ■ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Conditions	Rating	Unit
Power supply voltage	V <sub>CC</sub>	V <sub>CC</sub> , V <sub>CCO</sub>	20	V
Output current	I <sub>O</sub>	-	60	mA
Peak output current	I <sub>O</sub>	Duty ≤ 5 % (t = 1 / fosc × Duty)	700	mA
Power dissipation	P <sub>D</sub>	T <sub>a</sub> ≤ +25 °C	740*	mW
Storage temperature	T <sub>stg</sub>	-	-55 to +125	°C

\*: The package is mounted on the dual-sided epoxy board (10 cm × 10 cm).

**WARNING:** Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

## ■ RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Power supply voltage	V <sub>CC</sub>	V <sub>CC</sub> , V <sub>CCO</sub>	7	-	19	V
Reference voltage output current	I <sub>REF</sub>	-	-1	-	0	mA
VH pin output current	I <sub>VH</sub>	-	0	-	(30)	mA
Input voltage	V <sub>INE</sub>	-INE1, +INE2	0	-	V <sub>CC</sub> - 0.9	V
	V <sub>DTC</sub>	DTC1, DTC2	(0.3)	-	(V <sub>CC</sub> - 0.9)	V
CTL pin input voltage	V <sub>CTL</sub>	-	0	-	19	V
Output current	I <sub>O</sub>	-	-45	-	45	mA
Peak Output current	I <sub>O</sub>	Duty ≤ 5%(t = 1 / fosc × Duty)	-450	-	450	mA
Oscillation frequency	f <sub>OSC</sub>	-	100	500	(1000)	kHz
Timing capacitor	C <sub>T</sub>	-	(47)	(100)	(560)	pF
Timing resistor	R <sub>T</sub>	-	(12)	(24)	(120)	kΩ
VH pin capacitor	C <sub>VH</sub>	-	-	0.1	1.0	μF
Soft-start capacitor	C <sub>S</sub>	CS1, CS2	-	(0.1)	(1.0)	μF
Short-circuit protection capacitor	C <sub>SCP</sub>	-	-	(0.1)	(1.0)	μF
Reference voltage output capacitor	C <sub>REF</sub>	-	-	0.1	1.0	μF
Operating ambient temperature	T <sub>a</sub>	-	-30	+25	+85	°C

### WARNING:




The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

## ELECTRICAL CHARACTERISTICS

(Ta=25°C, VCC=12V, VCCO=12V, VREF=0mA)

Parameter	Symbol	Pin No.	Conditions	Min.	Typ.	Max.	Unit
<b>1.Reference voltage block (REF)</b>							
Output voltage	VREF	17	-	(4.95)	(5.00)	(5.05)	V
Input stability	Line	17	VCC = 7V to 19V	-	3	10	mV
Load stability	Load	17	VREF = 0 mA to -1 mA	-	1	10	mV
Short-circuit output current	IOS	17	VREF = 1 V	(-50)	(-25)	(-12)	mA
<b>2.Under voltage lockout protection circuit (UVLO)</b>							
Threshold voltage	VTLH	17	VREF 	(2.6)	2.8	(3.0)	V
	VTHL	17	VREF 	(2.4)	2.6	(2.8)	V
Hysteresis width	VH	17	*	-	(0.2)	-	V
<b>3.Short-circuit protection Logic block (SCP Logic)</b>							
Threshold voltage	VTH	8	-	0.68	0.73	0.78	V
Input source current	ICSCP	8	-	-1.4	-1.0	-0.6	μA
Reset voltage	VRST	17	VREF 	(2.4)	(2.6)	(2.8)	V
<b>4.Short-circuit protection Comparator block (SCP Com.)</b>							
Threshold voltage	VTH	8	-	(2.8)	3.1	(3.4)	V
<b>5.Triangular wave form oscillator block (OSC)</b>							
Oscillation frequency	fOSC	13	(CT=100pF, RT= 24 kΩ)	450	500	550	kHz
<b>6.Soft-start block (CS1,CS2)</b>							
Charge current	ICS	11,14	CS1=0V,CS2=0V	-14	-10	-6	μA
<b>7.Error amplifier block (Error Amp 1, Error Amp 2)</b>							
Threshold voltage	VIO	9,16	FB1=2V,FB2=2V	(1.227)	(1.240)	(1.253)	V
Input bias current	IB	10,15	-INE1=0V,-INE2=0V	(-120)	(-30)	-	nA
Voltage gain	AV	9,16	DC	-	100	-	dB
Frequency bandwidth	BW	9,16	AV = 0dB	-	(1.6)	-	MHz
Output voltage	VOH	9,16	-	4.7	4.9	-	V
	VOL	9,16	-	-	40	200	mV
Output source current	ISOURCE	9,16	FB1=2V,FB2=2V	-	-2	-1	mA
Output sink current	ISINK	9,16	FB1=2V,FB2=2V	150	200	-	μA

\* : Standard design value

(Ta=25°C,VCC=12V,VCCO=12V,VREF=0mA)

Parameter	Symbol	Pin No.	Conditions	Min.	Typ.	Max.	Unit
<b>8.PWM comparator block (PWM Comp.1,PWM Comp.2)</b>							
Threshold voltage	V <sub>T0</sub>	6,19	Duty cycle = 0 %	(1.4)	(1.5)	-	V
	V <sub>T100</sub>	6,19	Duty cycle = 100 %	-	(2.5)	(2.6)	V
Input bias current	I <sub>DTC</sub>	6,19	DTC1=0.4V,DTC2=0.4V	(-2.0)	(-0.6)	-	μA
<b>9.Overcurrent protection circuit block (OCP1,OCP2)</b>							
ILIM terminal input current	I <sub>LIM</sub>	5,20	R <sub>T</sub> =24kΩ	(99)	(110)	(121)	μA
Offset voltage	V <sub>IO</sub>	5,20	*	-	1	-	mV
<b>10.Bias voltage (VH)</b>							
Output voltage	V <sub>H</sub>	2	VCC=VCCO=7V to 19V , VH=0 to 30mA	(Vcc-5.5)	(Vcc-5.0)	(vcc-4.5)	V
<b>11.Output block (Drive1,Drive2)</b>							
Output source current	I <sub>SOURCE</sub>	3,22	OUT1 = 7V,OUT2 = 7V,Duty ≤ 5%	-	(-200)	(-100)	mA
Output sink current	I <sub>SINK</sub>	3,22	OUT1 = 12V,OUT2 = 12V,Duty ≤ 5%	(100)	(200)	-	mA
Output ON resistor	R <sub>OH</sub>	3,22	OUT1 = -45 mA OUT2 = -45 mA	-	(8.0)	(12.0)	Ω
	R <sub>OL</sub>	3,22	OUT1 = 45 mA OUT2 = 45 mA	-	(6.5)	(9.7)	Ω
<b>12.Control block (CTL)</b>							
CTL input voltage	V <sub>IH</sub>	24	Operating mode	2	-	19	V
	V <sub>IL</sub>	24	Standby mode	0	-	0.8	V
Input current	I <sub>CTLH</sub>	24	CTL = 5 V	-	(50)	(100)	μA
	I <sub>CTL</sub>	24	CTL = 0 V	-	-	1	μA
<b>13.General</b>							
Standby current	I <sub>CCS</sub>	1,7	CTL = 0V	-	(0)	(10)	μA
Power supply current	I <sub>CC</sub>	1,7	CTL = 5V	-	(5.0)	(7.5)	mA

\* : Standard design value

## **FUNCTIONAL DESCRIPTION**

### Control block (CTL)

As CTL terminal is setting "L" level, IC is the standby mode. The supply current in the standby mode is 10 $\mu$ A maximum.

#### Functional matrix by the control circuit operating

CTL	IC
L	OFF(Standby)
H	ON(Operating)

### Protection circuit

#### Functional matrix by the protection circuit operating

Operation circuit	CS1	CS2	OUT1	OUT2
Short-circuit protection circuit	L	L	H	H
Under voltage lockout protection circuit	L	L	H	H
Overcurrent protection circuit	L	L	H	H



## SETTING THE TIMER-LATCH SHORT-CIRCUIT PROTECTION

Each channel uses the short-circuit detection comparator (SCP Comp.) to always compare the error amp's output level to the reference voltage.

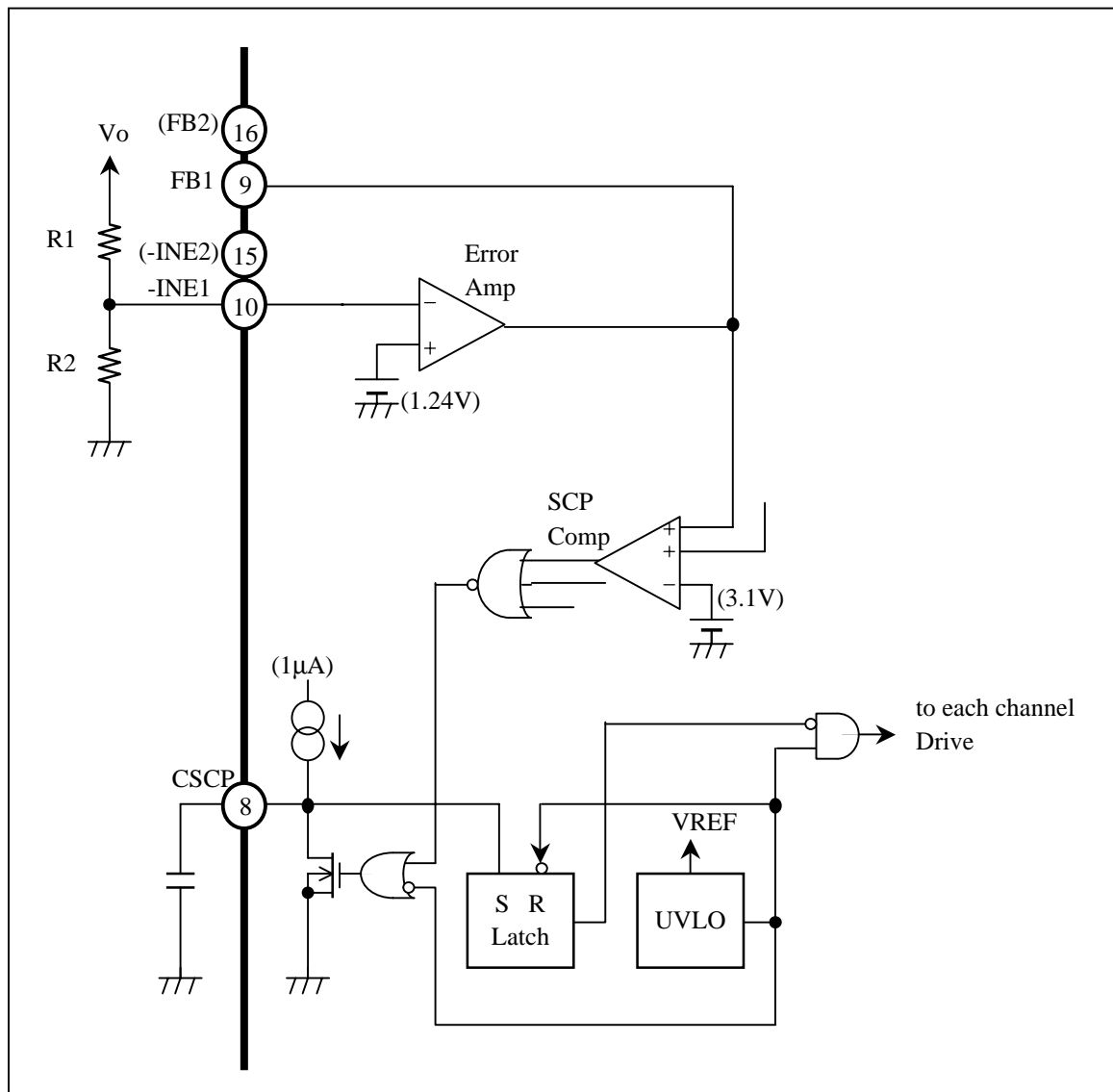
While the DC/DC converter load conditions are stable on both channels, the short-circuit detection comparator keeps its output at the "L" level and the CSCP terminal (pin 8) remains at the "L" level.

If a load condition changes rapidly due to a short-circuit of the load, causing the output voltage to drop, the short-circuit detection comparator changes its output to the "H" level. This causes the external short-circuit protection capacitor Cscp connected to the CSCP terminal to be charged at 1μA.

Short-circuit detection time : tscp

$$tscp (s) \cong 0.73 \times Cscp (\mu F)$$

When the capacitor Cscp is charged to the threshold voltage ( $V_{TH} \cong 0.73V$ ), the protection circuit sets the latch and turns off the external FET (setting the dead time to 100%). At this time, the latch input is closed and the CSCP terminal (pin 8) is held at the "L" level.



<Timer-latch short-circuit protection circuit>

## SETTING THE OVERCURRENT DETECTION CURRENT

The overcurrent protection circuit is actuated upon completion of the soft-start period.

If an overcurrent flows, the circuit detects the increase in the voltage between the main side FET's drain and source by the main side FET ON resistor (RON). When the state of overcurrent continues more than time set by capacitor connected with CSCP terminal (pin 3, pin 22), output is fixed at "H" level.

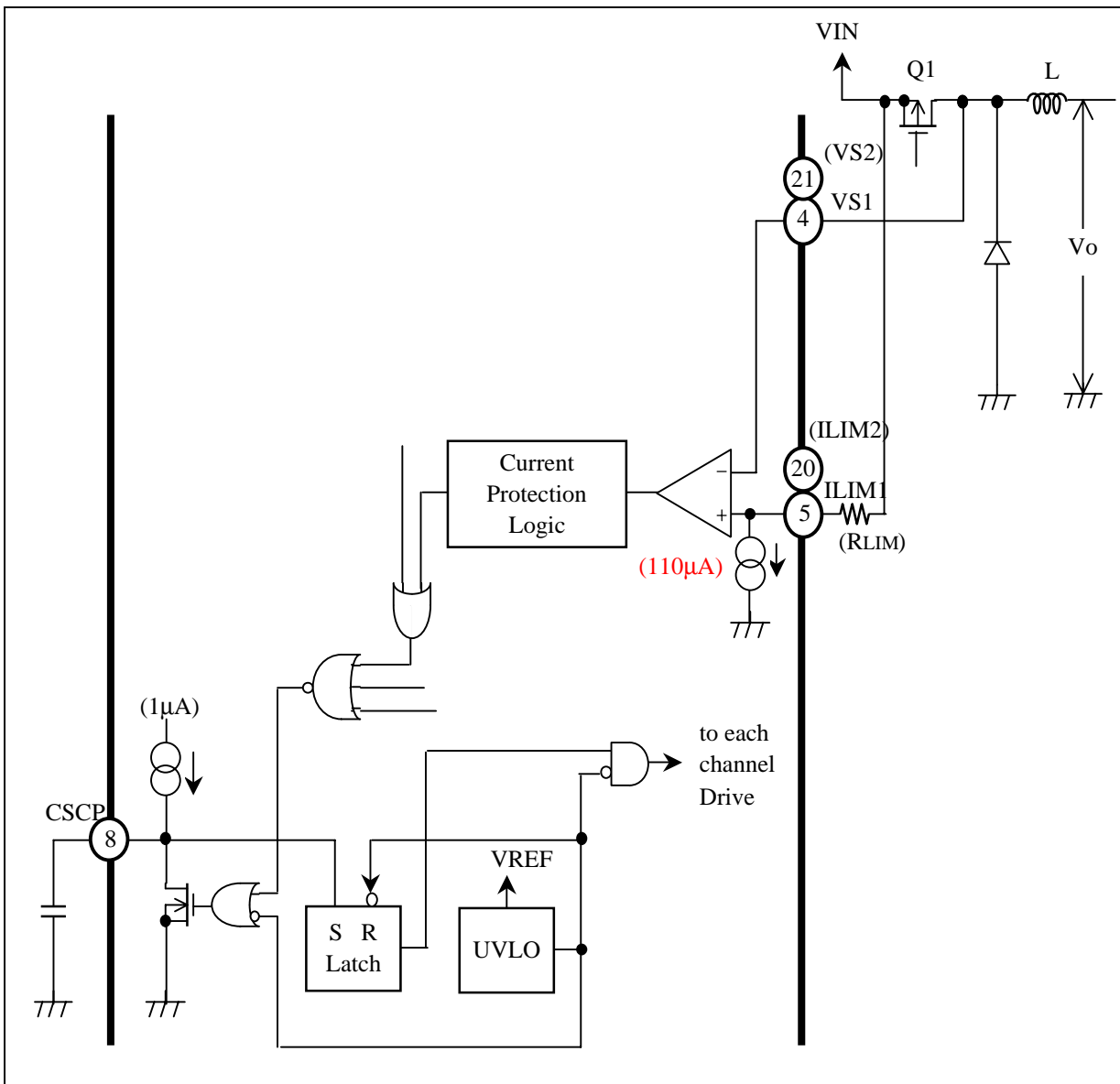
The detection current value can be set by the resistors (RLIM) connected between the drain of FET (Q1) and ILIM 1,2 terminal (pin 5, pin 20).

Detection current value : IOCP

$$IOCP(A) \cong \frac{ILIM \times RLIM}{R_{on}} - \frac{(V_{IN} - V_o) \times V_o}{2 \times V_{IN} \times f_{osc} \times L}$$

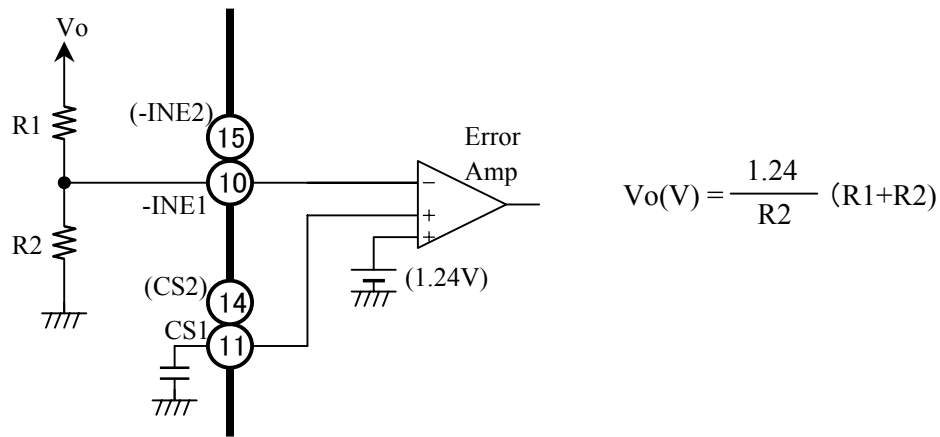
$$ILIM(A) \cong \frac{2.7}{R_T}$$

Note) The detection current value is influenced by ON resistor (RON) difference (contains the temperature characteristic) on the external FET(Q1) and the board pattern. Therefore, please confirm current value with the board actually used when you set the detection current value.



<Overcurrent detection circuit>

## SETTING THE OUTPUT VOLTAGE



## SETTING THE TRIANGULAR WAVE OSCILLATOR FREQUENCY

The triangular wave oscillation frequency can be set by the timing resistor ( $R_T$ ) connected the RT terminal (pin 12) and the timing capacitor ( $C_T$ ) connected the CT terminal (pin 13).

Triangular wave oscillation frequency : fosc

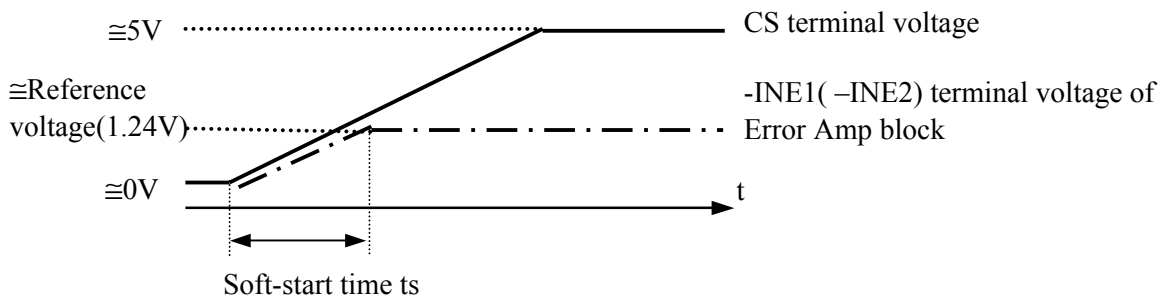
$$f_{osc}(kHz) \cong \frac{1200000}{C_T(pF) \times R_T(k\Omega)}$$

## SETTING THE SOFT START TIME

The soft-start function prevents rush current events when the IC power is turned on, by connecting soft-start capacitor ( $C_{S1}, C_{S2}$ ) to the CS terminal (pin 11, pin 14). The CTL terminal (pin 24) becomes "H" level, and when the IC is activated (more than UVLO threshold voltage), IC charges to external soft start capacitor ( $C_{S1}, C_{S2}$ ) of the CS1, CS2 terminal at  $10\mu A$ . Because the error amp Output terminal (FB1 (pin 9) (FB2 (pin 16))) is determined by the comparison to the lower of the two non-inverted input terminals (Reference voltage (1.24V), CS1 terminal voltage (CS2 terminal voltage)) to the inverted input terminal (-INE1 (pin 10), -INE2 (pin 15)) voltage, the FB1 (FB2) of the soft start interval is determined by the comparison to the Reference voltage (1.24V) and CS1 terminal voltage. Thus the DC/DC converter output voltage rises in proportion to the CS1 (CS2) terminal voltage as the external soft-start capacitor connected to the CS1 (CS2) terminal charges. The soft start time is determined by the following formula.

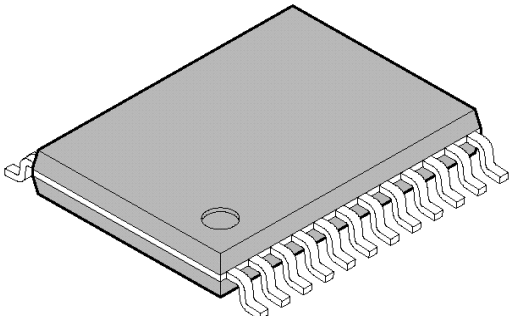
Soft-start time :  $t_s$  (time to output 100%)

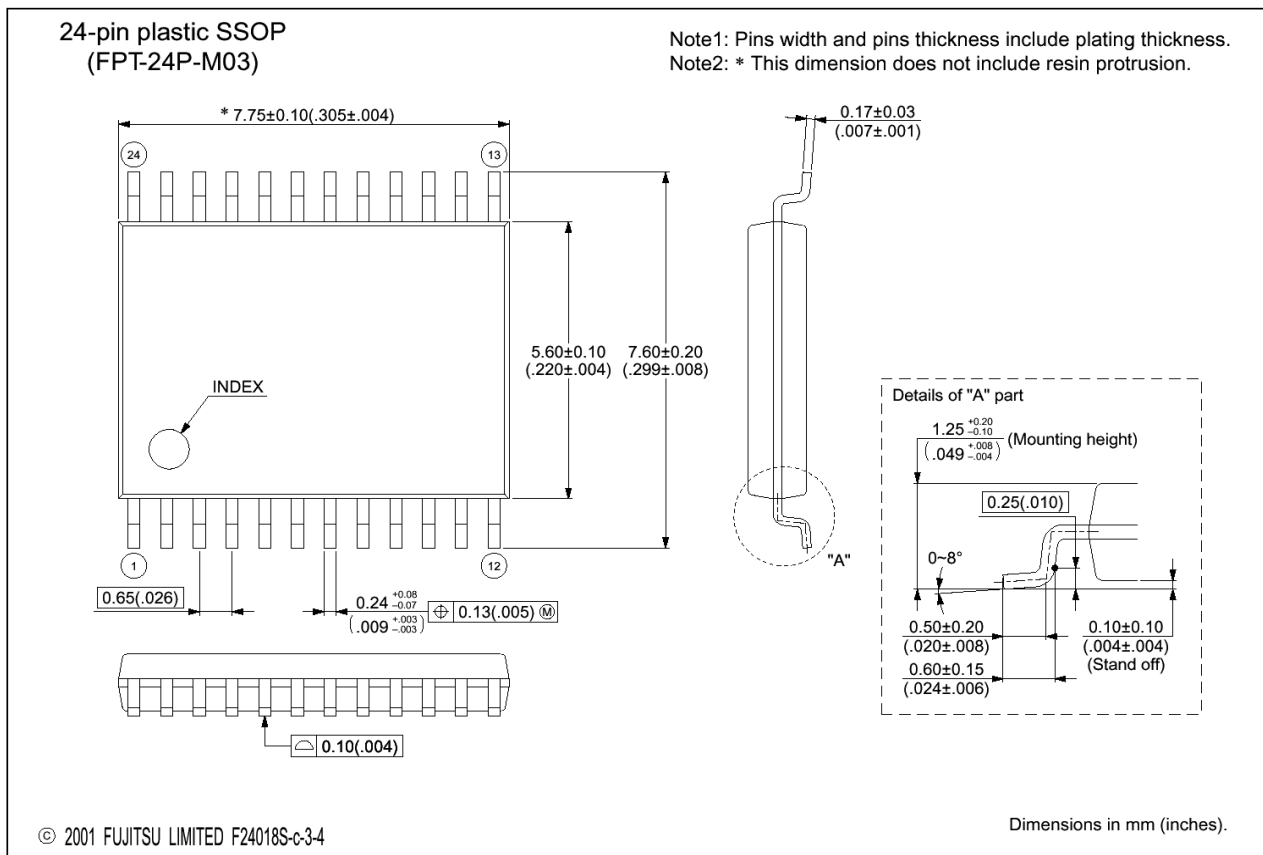
$$t_s (s) \cong 0.124 \times C_s (\mu F)$$



**PACKAGE DIMENSION**

**FPT-24P-M03**

<p>24-pin plastic SSOP</p>  <p>(FPT-24P-M03)</p>	Lead pitch	0.65 mm
	Package width × package length	5.6 × 7.75 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	1.45 mm MAX
	Weight	0.12 g
	Code (Reference)	P-SSOP24-5.6×7.75-0.65



## **■ USAGE PRECAUTIONS**

**1. Printed circuit board ground lines should be set up with consideration for common impedance.**

**2. Take appropriate static electricity measures.**

- Containers for semiconductor materials should have anti-static protection or be made of conductive material.
- After mounting, printed circuit boards should be stored and shipped in conductive bags or containers.
- Work platforms, tools, and instruments should be properly grounded.
- Working personnel should be grounded with resistance of 250 kW to 1 MW between body and ground.

**3. Do not apply negative voltages.**

The use of negative voltages below -0.3V may create parasitic transistors on LSI lines, which can cause abnormal operation.

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